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(12) **United States Design Patent** (10) **Patent No.:** **US D968,377 S**
Armstrong et al. (45) **Date of Patent:** **** Nov. 1, 2022**

- (54) **CASE FOR MOBILE ELECTRONICS**
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- (73) Assignee: **Urban Armor Gear, LLC**, Laguna Niguel, CA (US)
- (**) Term: **15 Years**

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(Continued)

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- (22) Filed: **Jan. 3, 2020**
- (51) **LOC (13) Cl.** **14-03**
- (52) **U.S. Cl.**
USPC **D14/250**
- (58) **Field of Classification Search**
USPC D14/143, 199, 201, 202, 217, 250, 251, D14/253, 440, 447, 316
CPC H04M 1/0283; H04M 1/0202; A45C 1/06; A45C 2011/002; A45C 11/00; A45F 2005/028; A45F 2200/0525
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a case for mobile electronics, as shown and described.

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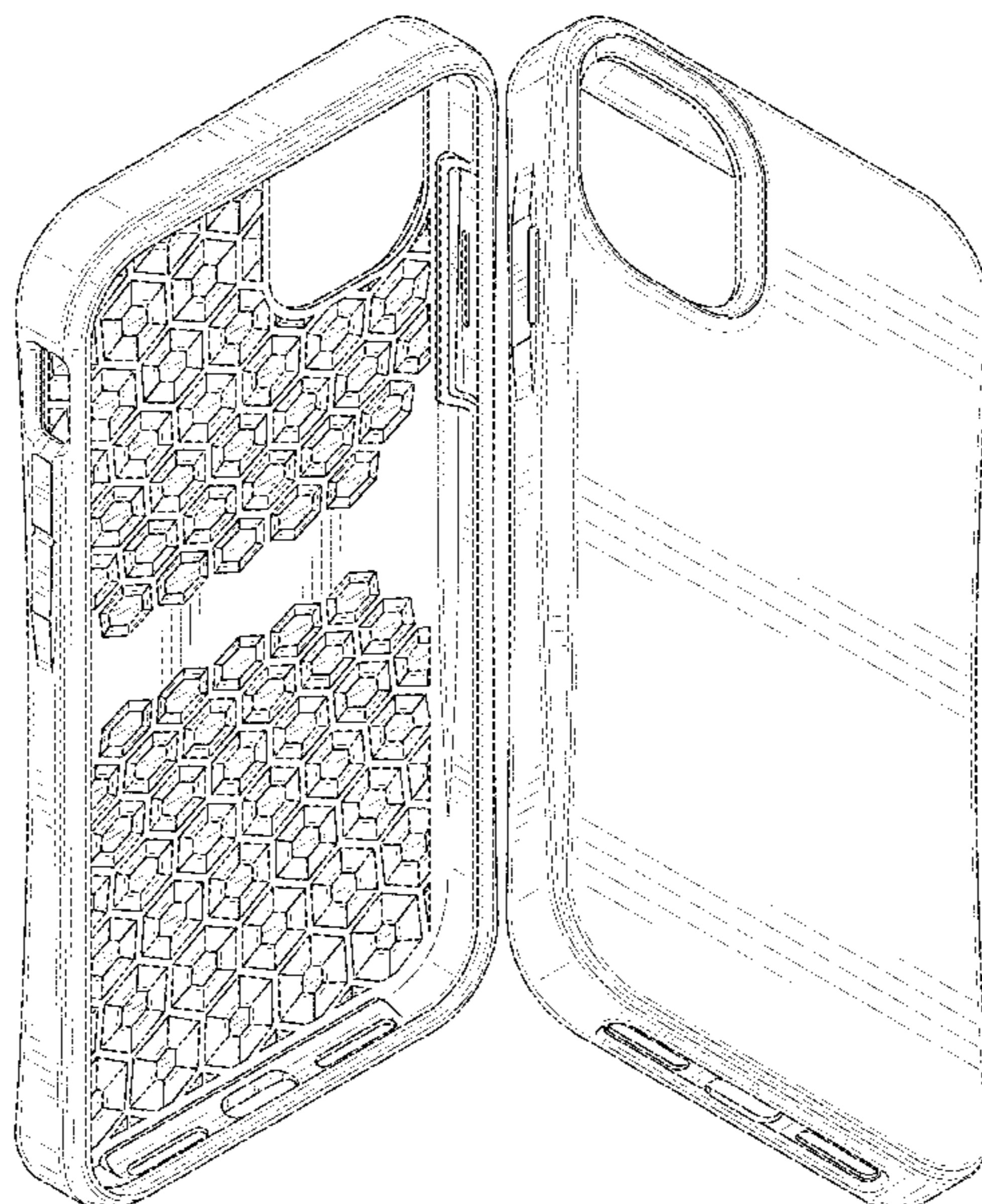
DESCRIPTION

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FIG. 1 is a front-right perspective view of a case for mobile electronics, showing our new design; FIG. 2 is a back-left perspective view of the case of FIG. 1. FIG. 3 is a front elevation view of the case of FIG. 1. FIG. 4 is a back elevation view of the case of FIG. 1. FIG. 5 is a right-side elevation view of the case of FIG. 1. FIG. 6 is a left-side elevation view of the case of FIG. 1. FIG. 7 is a top plan view of the case of FIG. 1; and, FIG. 8 is a bottom plan view of the case of FIG. 1. Shading forms no part of the claim.

1 Claim, 8 Drawing Sheets



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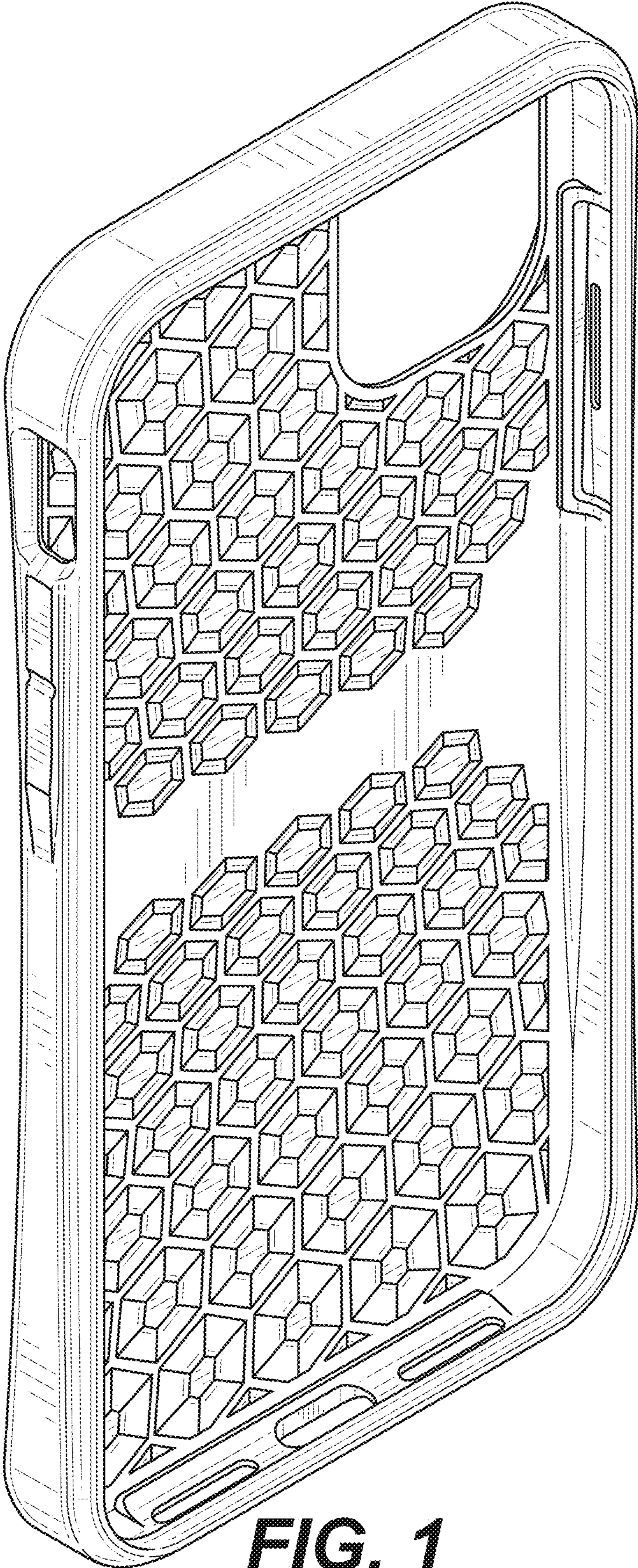


FIG. 1

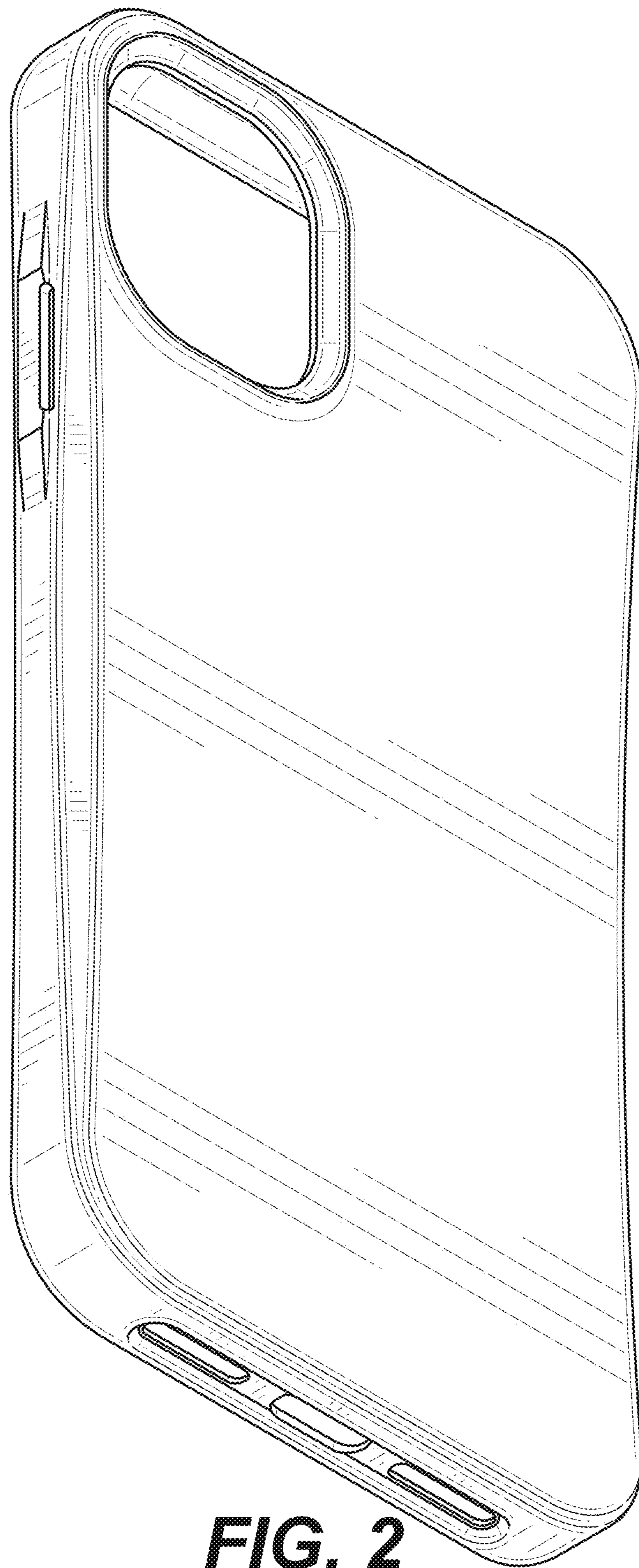


FIG. 2

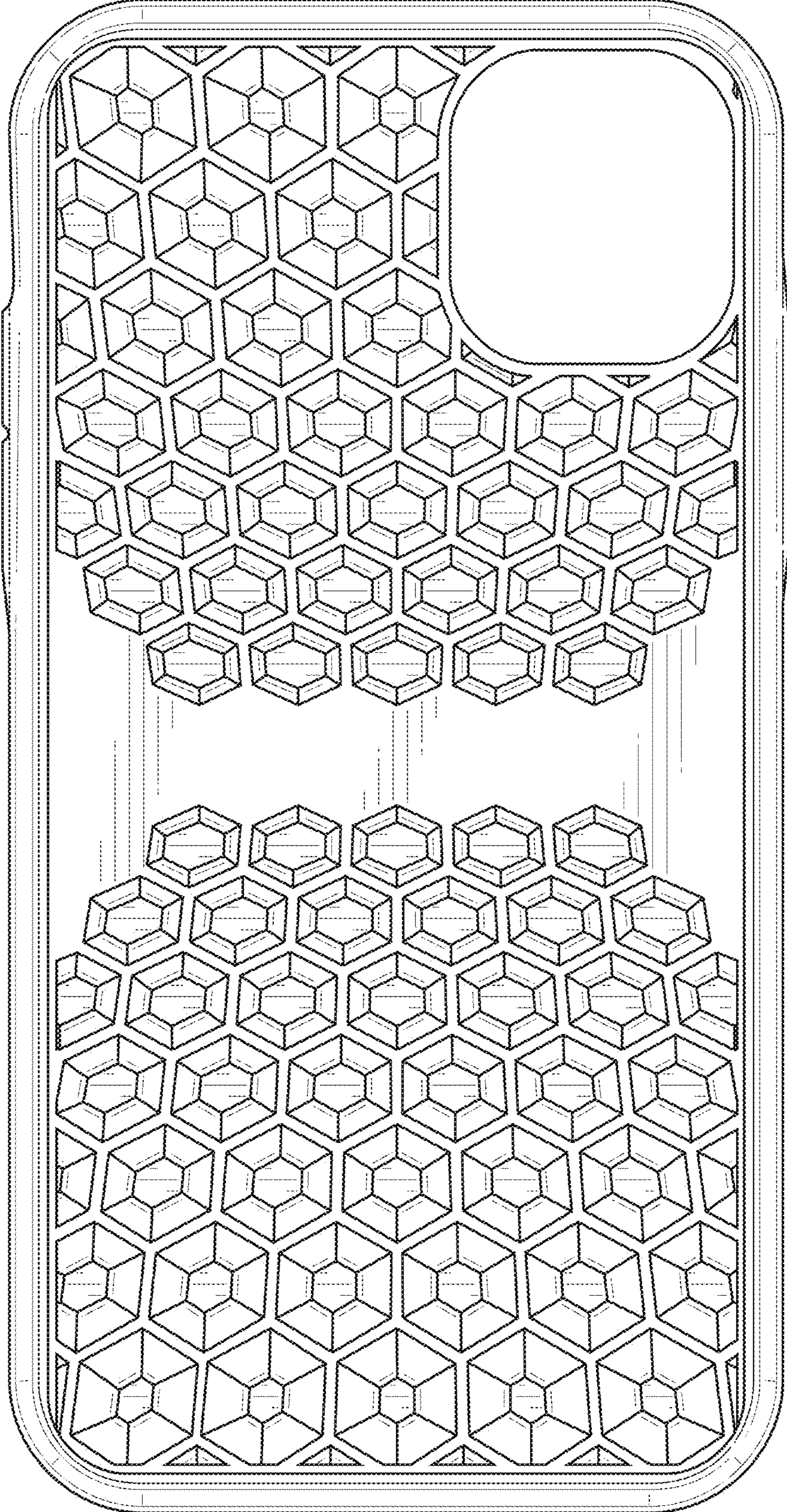


FIG. 3

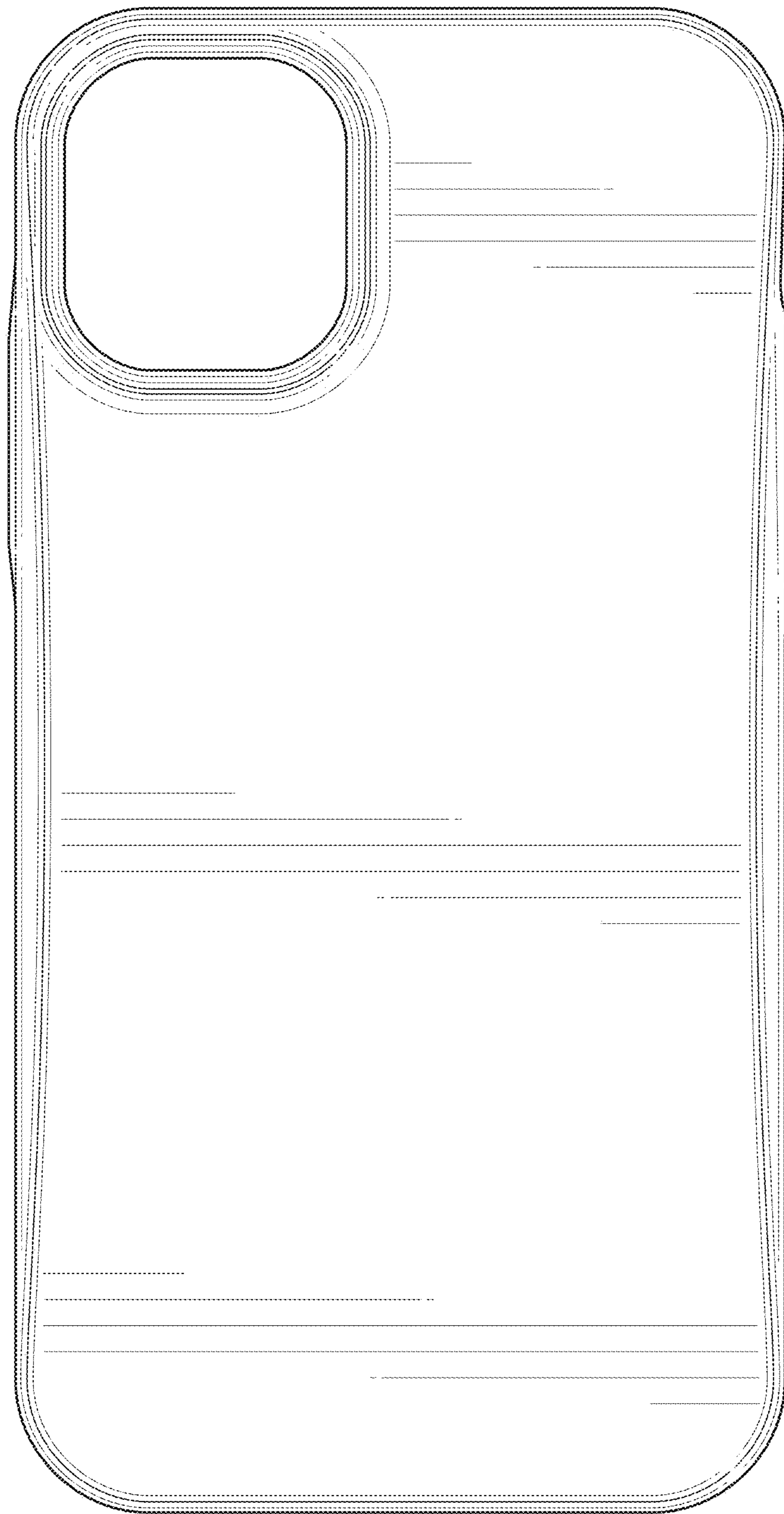


FIG. 4

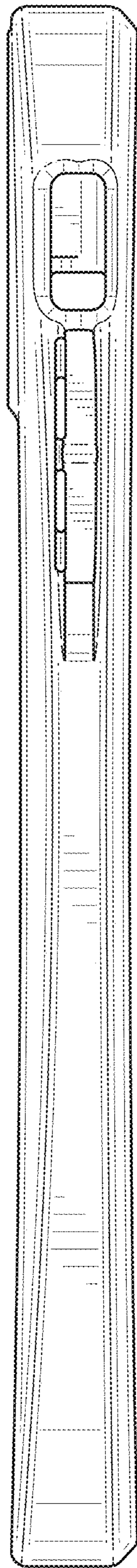


FIG. 5

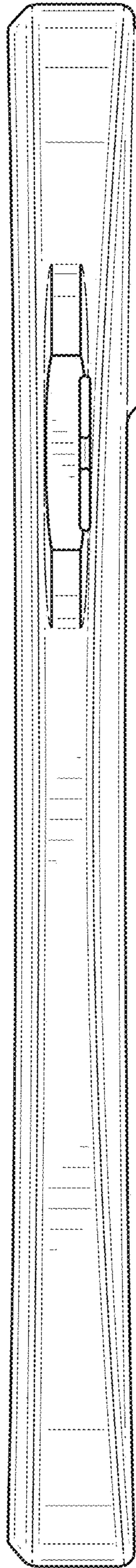


FIG. 6

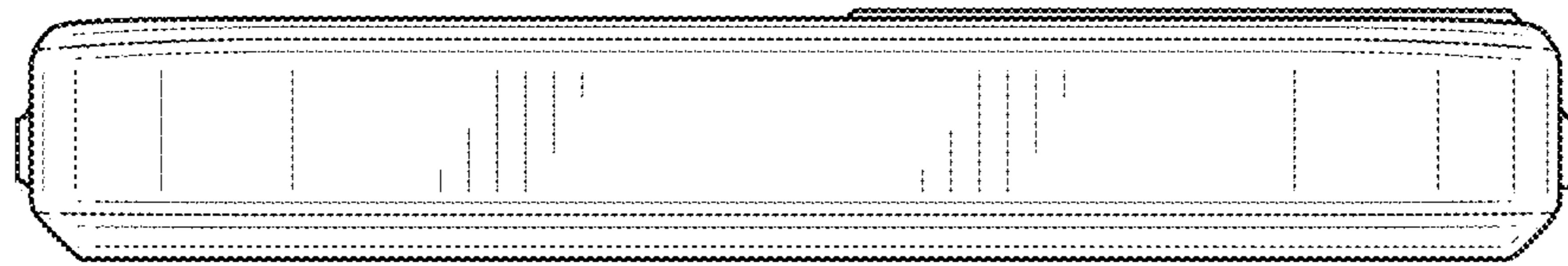


FIG. 7

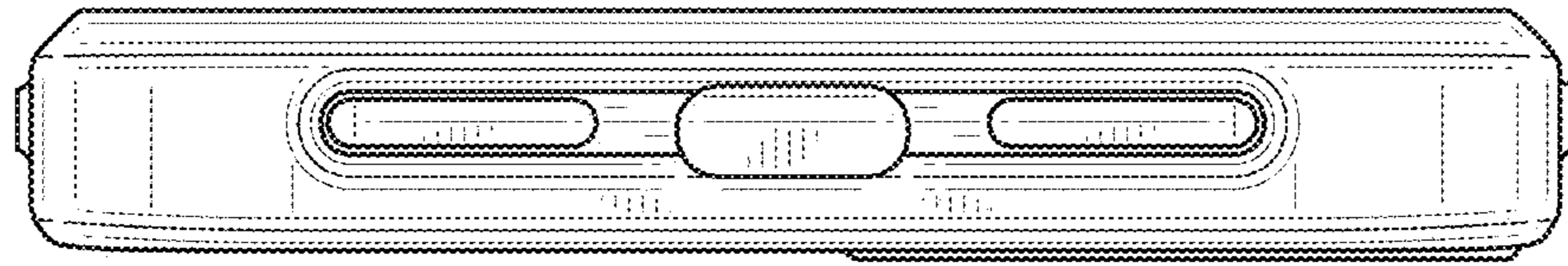


FIG. 8